S1ABH – S1MBH

Taiwan Semiconductor



1A, 50V - 1000V Surface Mount Rectifier

FEATURES

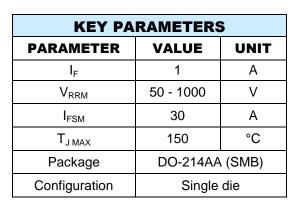
- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- DC to DC converter
- Automotive application
- Car lighting
- Snubber
- Freewheeling application

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.090g (approximately)









Cathode Anode

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	S1 ABH	S1 BBH	S1 DBH	S1 GBH	S1 JBH	S1 KBH	S1 MBH	UNIT
Marking code on the device		S1 AB	S1 BB	S1 DB	S1 GB	S1 JB	S1 KB	S1 MB	
Repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V _{R(RMS)}	35	70	140	280	420	560	700	V
Forward current	١ _F				1				Α
Surge peak forward current, 8.3ms single half sine-wave superimposed on rated load	I _{FSM}				30				A
Junction temperature	TJ			- {	55 to +1	50			°C
Storage temperature	T _{STG}			- {	55 to +1	50			°C



PARAMETER	SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	R _{ƏJL}	30	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage ⁽¹⁾	$I_{F} = 1A, T_{J} = 25^{\circ}C$	V _F	-	1.1	V
	$T_J = 25^{\circ}C$	I	-	5	μA
Reverse current @ rated V _R ⁽²⁾	T _J = 125°C	I _R	-	50	μA
Junction capacitance	1MHz, V _R = 4.0V	CJ	12	-	pF

Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION			
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING	
S1xBH	DO-214AA (SMB)	3,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 50V(S1ABH) to 1000V(S1MBH)



CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

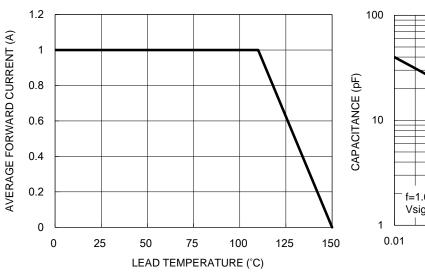


Fig.1 Forward Current Derating Curve

Fig.2 Typical Junction Capacitance

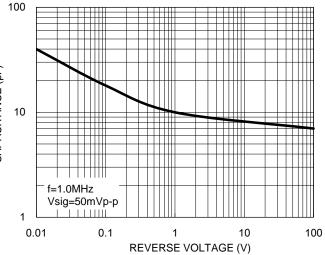
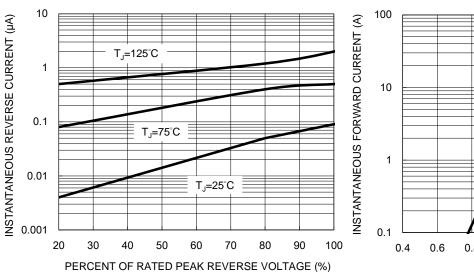
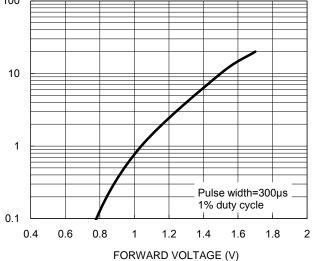


Fig.3 Typical Reverse Characteristics

Fig.4 Typical Forward Characteristics



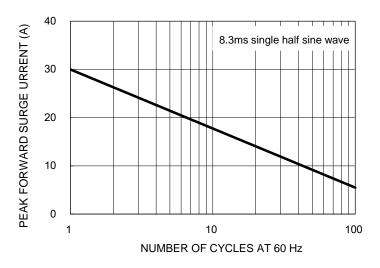




CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

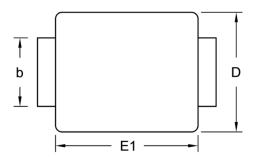
Fig.5 Maximum Non-repetitive Forward Surge Current

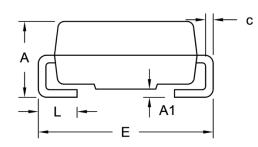




PACKAGE OUTLINE DIMENSIONS

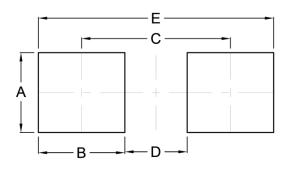
DO-214AA (SMB)





DIM.	Unit (mm)		Unit	inch)	
	Min.	Max.	Min.	Max.	
A	1.95	2.65	0.077	0.104	
A1	0.05	0.20	0.002	0.008	
b	1.95	2.20	0.077	0.087	
с	0.15	0.31	0.006	0.012	
D	3.30	3.95	0.130	0.156	
E	5.10	5.60	0.201	0.220	
E1	4.05	4.60	0.159	0.181	
L	0.75	1.60	0.030	0.063	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	2.30	0.091
В	2.50	0.098
С	4.30	0.169
D	1.80	0.071
E	6.80	0.268

MARKING DIAGRAM



P/N	= Marking Code
G	= Green Compound

YW = Date Code

F = Factory Code



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